3. General Use FC, FA, FB







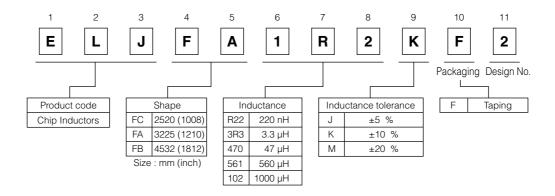
■ Features

- General use wire wound, resin molded chip inductor.
- Capable of being Re-flow or flow soldered.
- Wide line-up from 2520 to 4532 case sizes.
- Good for mounting.
- RoHS compliant

■ Recommended Applications

• AV equipment, Wireless communication equipment and various types of general electronic equipment.

■ Explanation of Part Numbers



■Storage Conditions

◆ Package : Normal temperature (-5 to 35 °C), normal humidity (85 %RH max.), shall not be exposed to

direct sunlight and harmful gases and care should be taken so as not to cause dew.

● Operating Temperature : -20 to +85 °C

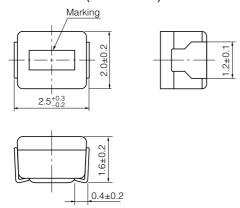
■Storage Period

Solderability may be reduced due to the conditions of high temperature and high humidity which causes the oxidation of tin-plated terminals. Even if storage conditions are within specified limits, solderability may be reduced with the passage of time. Therefore, please control the storage conditions and try to use the product within 6 months of receipt.

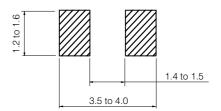
■ Packaging Methods, Soldering Conditions and Safety Precautions

Please see Data Files.

- FC Type 2520 (1008)
- Dimensions in mm (not to scale)



Recommended Land Pattern in mm (not to scale)



- Standard Packing Quantity
- 2000 pcs./Reel

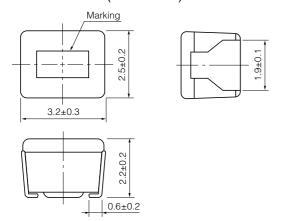
■ Standard Parts

		Inductance		(2	SRF *1	Roc *²	DC Current
Part No.	(µH)	Tolerance (%)	Test Freq. (MHz)	min.	Test Freq. (MHz)	(MHz) min.	(Ω) max.	(mA) max.
ELJFCR22□F	0.22					230	0.70	190
ELJFCR27□F	0.27	1				210	0.75	180
ELJFCR33□F	0.33	M: ±20 %				190	0.85	170
ELJFCR39□F	0.39]	05.0		05.0	175	0.95	160
ELJFCR47□F	0.47	or	25.2		25.2	160	1.00	155
ELJFCR56□F	0.56	K: ±10 %				155	1.10	150
ELJFCR68□F	0.68					135	1.25	140
ELJFCR82□F	0.82					125	1.40	130
ELJFC1R0□F	1.0					115	0.65	195
ELJFC1R2□F	1.2					100	0.75	180
ELJFC1R5□F	1.5					90	0.85	170
ELJFC1R8□F	1.8				7.96	85	0.95	160
ELJFC2R2□F	2.2			25		80	1.05	155
ELJFC2R7□F	2.7		7.96			75	1.20	145
ELJFC3R3□F	3.3					65	1.30	135
ELJFC3R9□F	3.9					60	1.40	130
ELJFC4R7□F	4.7					55	1.55	125
ELJFC5R6□F	5.6					50	1.75	120
ELJFC6R8□F	6.8					45	1.95	115
ELJFC8R2□F	8.2	K: ±10 %				40	2.20	105
ELJFC100□F	10	or				32	3.70	80
ELJFC120□F	12] J:±5%				30	4.10	75
ELJFC150□F	15					28	5.00	70
ELJFC180□F	18					25	5.40	65
ELJFC220□F	22					22	6.00	60
ELJFC270□F	27		2.52		2.52	21	6.30	115
ELJFC330□F	33		2.52		2.52	20	7.10	110
ELJFC390□F	39					18	9.50	90
ELJFC470□F	47			20		17	11.0	80
ELJFC560□F	56					16	12.1	75
ELJFC680□F	68					15	16.6	70
ELJFC820□F	82					13	19.0	65
ELJFC101□F	100		0.796	15	0.796	12	21.0	60

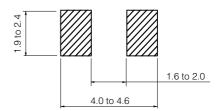
 $[\]hfill\Box$: Symbol of Tolerance

^{*1 :} Self Resonant Frequency *2 : DC Resistance

- FA Type 3225 (1210)
- Dimensions in mm (not to scale)



Recommended Land Pattern in mm (not to scale)



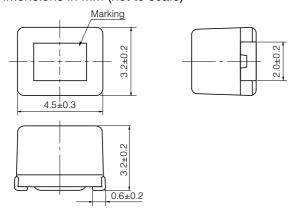
- Standard Packing Quantity
- 2000 pcs./Reel

■ Standard Parts

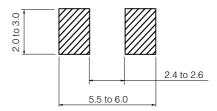
		Inductance		(Q	SRF *1	D #2	DC Current
Part No.	(µH)	Tolerance (%)	Test Freq. (MHz)	min.	Test Freq. (MHz)	(MHz) min.	$R_{\rm DC}$ *2 (Ω) max.	DC Current (mA) max.
ELJFAR22□F2	0.22					230	0.29	360
ELJFAR27□F2	0.27	1				210	0.32	345
ELJFAR33□F2	0.33	M: ±20 %				190	0.35	330
ELJFAR39□F2	0.39		25.2	25	25.2	175	0.39	305
ELJFAR47□F2	0.47	or	25.2	25	25.2	160	0.44	290
ELJFAR56□F2	0.56	K: ±10 %				150	0.49	275
ELJFAR68□F2	0.68					135	0.55	260
ELJFAR82□F2	0.82]				125	0.61	245
ELJFA1R0□F2	1.0					115	0.69	230
ELJFA1R2□F2	1.2]				100	0.75	215
ELJFA1R5□F	1.5					90	0.75	210
ELJFA1R8□F	1.8					85	0.82	200
ELJFA2R2□F	2.2					80	0.95	190
ELJFA2R7□F	2.7		7.96		7.96	75	1.1	180
ELJFA3R3□F	3.3		7.90		7.90	65	1.2	180
ELJFA3R9□F	3.9					60	1.3	175
ELJFA4R7□F	4.7					55	1.5	165
ELJFA5R6□F	5.6					50	1.6	160
ELJFA6R8□F	6.8					45	1.8	150
ELJFA8R2□F	8.2			30		40	2.0	140
ELJFA100□F	10]		30		36	2.1	140
ELJFA120□F	12	K: ±10 %				33	2.5	125
ELJFA150□F	15	or				30	2.8	120
ELJFA180□F	18] J:±5%				27	3.3	110
ELJFA220□F	22					25	3.7	105
ELJFA270□F	27		2.52		2.52	22	5.0	90
ELJFA330□F	33		2.52		2.52	20	5.6	85
ELJFA390□F	39					20	6.4	80
ELJFA470□F	47					15	7.0	75
ELJFA560□F	56					15	8.0	70
ELJFA680□F	68					15	9.0	65
ELJFA820□F	82					10	10.0	60
ELJFA101□F	100					10	10.0	60
ELJFA121□F	120					10	11.0	55
ELJFA151□F	150		0.796	20	0.796	8	15.0	50
ELJFA181□F	180					7	17.0	50
ELJFA221□F	220					7	21.0	45

 $[\]square$: Symbol of Tolerance $\qquad {\rm \bf *1}$: Self Resonant Frequency $~{\rm \bf *2}$: DC Resistance

- FB Type 4532 (1812)
- Dimensions in mm (not to scale)



Recommended Land Pattern in mm (not to scale)



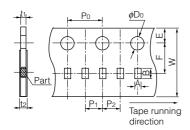
- Standard Packing Quantity
- 500 pcs./Reel

■ Standard Parts

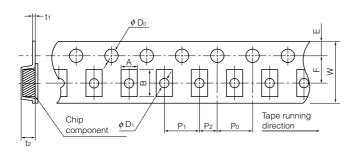
		Inductance			Q	- SRF *1	Rpc *2	DC Current
Part No.	(µH)	Tolerance (%)	Test Freq. (MHz)	min.	Test Freq. (MHz)	(MHz) min.	(Ω) max.	(mA) max.
ELJFBR22□F	0.22					230	0.30	700
ELJFBR27□F	0.27					200	0.32	650
ELJFBR33□F	0.33					180	0.35	630
ELJFBR39□F	0.39] M 00 0/				155	0.37	620
ELJFBR47□F	0.47	− M : ±20 %				135	0.40	580
ELJFBR56□F	0.56				05.0	120	0.42	560
ELJFBR68□F	0.68			30	25.2	105	0.48	530
ELJFBR82□F	0.82					90	0.50	500
ELJFB1R0□F	1.0					80	0.52	470
ELJFB1R2□F	1.2					70	0.55	460
ELJFB1R5□F	1.5	7				60	0.61	430
ELJFB1R8□F	1.8					50	0.61	410
ELJFB2R2□F	2.2	M:±20 %				45	0.61	410
ELJFB2R7□F	2.7	7			7.00	43	0.61	400
ELJFB3R3□F	3.3	or	1.0		7.96	39	0.66	380
ELJFB3R9□F	3.9	K:±10%				36	0.74	360
ELJFB4R7□F	4.7				_	33	0.81	350
ELJFB5R6□F	5.6					30	0.88	330
ELJFB6R8□F	6.8					26	1.0	310
ELJFB8R2□F	8.2	1				24	1.6	250
ELJFB100□F	10			50	5	22	1.8	235
ELJFB120□F	12					20	1.9	225
ELJFB150□F	15					18	2.1	215
ELJFB180□F	18					16	2.3	205
ELJFB220□F	22					15	2.6	195
ELJFB270□F	27	7				13	2.9	185
ELJFB330□F	33					12	3.1	175
ELJFB390□F	39					10	3.6	165
ELJFB470□F	47				2.52	9.7	4.2	130
ELJFB560□F	56	7			1	9.0	4.7	125
ELJFB680□F	68	7				8.2	5.3	115
ELJFB820□F	82	K: ±10 %				7.5	5.9	110
ELJFB101□F	100	or				6.7	8.8	105
ELJFB121□F	120	J:±5%				6.1	10	100
ELJFB151□F	150	7 0.50%		40	1.5	5.5	11	95
ELJFB181□F	180					5.1	13	85
ELJFB221□F	220		0.1			4.5	13	85
ELJFB271□F	270		0.1			4.1	14	80
ELJFB331□F	330					3.7	16	75
ELJFB391□F	390					3.3	19	70
ELJFB471□F	470				0.796	3.3	31	55
ELJFB561□F	560					2.7	35	50
ELJFB681□F	680			30		2.5	39	50
ELJFB821□F	820					2.4	45	45
ELJFB102□F	1000					2.1	53	40

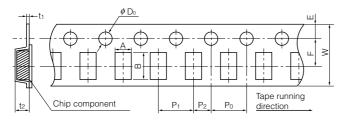
 $[\]square$: Symbol of Tolerance $\qquad {\rm \bf *1}$: Self Resonant Frequency $~{\rm \bf *2}$: DC Resistance

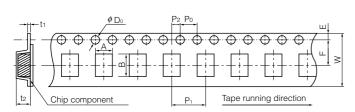
- Packaging Methods (Taping)
- Punched Carrier Tape Dimensions in mm (not to scale)



Embossed Carrier Tape Dimensions in mm (not to scale)







■ Type □F

	Α	В	W	Е	F	P ₁
RF, QF, PF	0.71	1.21	8.0	1.75	3.5	2.0
	P ₂	P ₀	ø D∘	t ₁	t ₂	
RF, QF, PF	P ₂	P ₀	<i>φ</i> D₀ <i>φ</i> 1.5	t ₁ 0.7 max.	t ₂	

■ Type □E, Type ND, Type □C

	Α	В	W	Е	F	P₁
RE, QE, PE	1.0	1.8	8.0	1.75	3.5	4.0
ND	1.45	2.25	8.0	1.75	3.5	4.0
NC, FC, PC, LC, SC	2.40	2.90	8.0	1.75	3.5	4.0
	P ₂	Po	ø D₀	ø D₁	t ₁	t ₂
RE, QE, PE	P ₂	P ₀ 4.0	<i>φ</i> D₀ <i>φ</i> 1.5	φD ₁ φ0.6	t ₁ (0.27)	t ₂
RE, QE, PE	-			,		

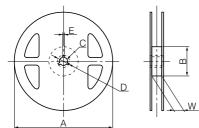
■ Type □A

	Α	В	W	Е	F	P ₁
NA, FA, PA, LA, SA, EA, DA	2.80	3.60	8.0	1.75	3.5	4.0
	P ₂	P ₀	ø D∘	t ₁	t ₂	
NA, FA, PA, LA, SA, EA, DA	2.0	4.0	φ1.5	(0.25)	2.40	•

■ Type □B

	A	В	W	Ē	F	P₁
FB, PB	3.60	4.90	12.0	1.75	5.5	8.0
	P ₂	Po	ø D∘	t ₁	t ₂	
FB, PB	2.0	4.0	φ1.5	(0.30)	3.50	

• Taping Reel Dimensions in mm (not to scale)



Parts Types	А	В	С	D	Е	W
RF, QF, PF, RE, QE, PE, ND, NC, FC, PC, LC, SC, NA, FA, PA, LA, SA, EA, DA	180	60	13	21	2	9
FB, PB	180	60	13	21	2	13

■ Standard Packing Quantity/Reel

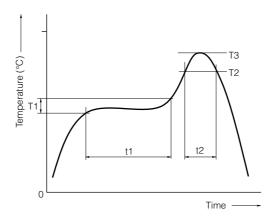
Types	Quantity	Quantity
RF, C)F, PF	10000 pcs.
RE, QE,	PE, ND	3000 pcs.
NC, FC, F	C, LC, SC	2000 pcs.
NA, FA, PA, L	A, SA, EA, DA	2000 pcs.
FB,	PB	500 pcs.

* Under conditions of high temperature and humidity deterioration of the taping and packaging may be accelerated.

Please carefully control storage conditions and use the product within 6 months of receipt.

Soldering Conditions

■ Reflow soldering conditions



Pb free solder recommended temperature profile

Type	Preheat		Soldering		Peak Temperature		Time of
туре	T1 [°C]	t1 [s]	T2 [°C]	t2 [s]	Т3	T3 Limit	Reflow
□F	150 to 180	60 to 120	230 °C	40 max.	250 °C, 10 s	260 °C, 10 s	2 times max.
□E	150 to 180	60 to 120	230 °C	40 max.	250 °C, 10 s	260 °C, 10 s	2 times max.
□D	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.
□С	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.
□A	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.
□В	150 to 180	60 to 120	230 °C	40 max.	245 °C, 10 s	250 °C, 10 s	2 times max.

■ Flow soldering conditions

Preheat: 130 to 150 °C, 60 to 180 s, Soldering: 260 °C, 5 s max.

■ Notes

- Solderability may be reduced due to the conditions of high temperature and high humidity which causes the oxidation
 of tin-plated terminals. Even if storage conditions are within specified limits, solderability may be reduced with the
 passage of time. Therefore, please control the storage conditions and try to use the product within 6 months of receipt.
- In case the product has been stored for a period longer than 6 months, use the product only after confirmation of its solderability.

(Common precautions for Chip Inductors)

- When using our products, no matter what sort of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this catalog are subject to change without prior notice.
- Do not use the products beyond the specifications described in this catalog.
- This catalog explains the quality and performance of the products as individual components. Before use, check and evaluate their operations when installed in your products.
- Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other significant damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/gas equipment, rotating equipment, and disaster/crime prevention equipment.
- * Systems equipped with a protection circuit and a protection device
- * Systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault

⚠ Precautions for use

1. Operation range and environments

- (1) These products are designed and manufactured for general and standard use in general electronic equipment (e.g. AV equipment, home electric appliances, office equipment, information and communication equipment)
- ② These products are not intended for use in the following special conditions. Before using the products, carefully check the effects on their quality and performance, and determine whether or not they can be used.
 - In liquid, such as water, oil, chemicals, or organic solvent
 - In direct sunlight, outdoors, or in dust
 - In salty air or air with a high concentration of corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NO₂
 - In an environment where these products cause dew condensation

2. Handling

- ① Do not bring magnets or magnetized materials close to the product. The influence of their magnetic field can change the inductance value.
- ② Do not apply strong mechanical shocks by either dropping or collision with other parts. Excessive schock can damage the part.

3. Land pattern design

- ① Please refer to the recommended land pattern for each type shown on the datasheet.
- ② Avoid placing the chip inductor on any metal pattern except the recommended land pattern because a drop of Q and mutual conductance may occur.
- ③ In case of flow soldering, venting of soldering flux gases should be made for high density assemblies to get a good solder connection.
- ④ In case of reflow soldering, consider the layout because taller components close to chip inductor tend to block thermal conduction.

4. Mounting

- (1) In general, magnetic and electric characteristics of ferrite cores can be changed by applying excessively strong force. Placement force should not exceed 20 N.
- 2 Do not bend or twist the PWB after mounting the part.

5. Cleaning

- ① Do not use acid or alkali agents. Some cleaning solvents may damage the part.
 - Confirm by testing the reliability in advance of mass production.
- ② If Ultrasonic cleaning is used, please confirm the reliability in advance. It is possible that combined resonance of component and PWB and cavitation can cause an abnormal vibration mode to exist causing damage.

6. Caution about applying excessive current

The rated current is defined as the smaller value of either the current value when the inductance drops 10 % down from the initial point or the current value when the average temperature of coil inside rises 20 °C up from the initial point. Do not operate product over the specific max. current.

<Package markings>

Package markings include the product number, quantity, and country of origin. In principle, the country of origin should be indicated in English.

Chip Inductors

Type: **F, E, D, C, A, B**F E D C A B

(Size 1005) (Size 1608) (Size 2012) (Size 2520) (Size 3225) (Size 4532)

Ceramic Core/Laser-Cut and wire wound type chip inductors for automatic and high-density mounting Wide variation product line-up correspond to various needs

■ Recommended Applications

 Cellular phones, wireless communication equipment (W-LAN, Bluetooth), various modules, HIC, TV, VTR, PC & peripherals, DVD, DSC, STB.

■ Inductors · Selection Guide

Size: mm (inch)

Inductors · Select	otion daide					Size : mm (inch)	
Technology	Non v	vound		Wire wound			
Usage	Size 1005 (0402)	Size 1608 (0603)	Size 2012 (0805)	Size 2520 (1008)	Size 3225 (1210)	Size 4532 (1812)	
	ELJRF	ELJRE	ELJND	ELJNC	ELJNA		
High Freq. Use	•	*	•				
	1.0–100 nH	1.0-220 nH	10–1000 nH	10-820 nH	47–8200 nH		
	ELJQF	ELJQE					
High Freq. High-Q	•	*					
	1.0–39 nH	2.2–56 nH					
				ELJFC	ELJFA	ELJFB	
General Use				•			
				0.22-100 µH	0.22-220 µH	0.22-1000 µH	
	ELJPF	ELJPE		ELJPC/PC□3 ELJLC	ELJPA/PA□2 ELJLA	ELJPB	
High Power	•	•		ELUC	ELULA		
	2.2–10 nH	2.2–22 nH		1.0–33 µH	1.0–330 µH	10–220 μH	
				ELJSC	ELJSA		
Magnetically Shielded							
				27–100 μH	10–270 μΗ		
					ELJEA		
Low DC Resistance							
					1.0–330 µH		
Signal					ELJDA/ELJFA		
Processing Use (Low Distortion Type)							
(Low Distortion Type)					39–100 μΗ		

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

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ECE-A1HKAR47 ELK-EA102FA ELC-09D151F EEC-S0HD224H ELL-5PS3R3N HC2-H-DC48V-F HL2-HP-AC120V-F HL2-H-DC12V-F HL2-HP-DC6V-F HL2-HP-DC24V-F HC4-H-DC24V HL2-HTM-DC24V-F HL2-HTM-AC24V-F HC4-H-AC24V HC4-H-AC120V EEC-RG0V155H AZH2031 RP-SDMF64DA1 EEF-UD0K101R EVM-F6SA00B55 RP-SMLE08DA1 ELC-12D101E ERA-3YEB272V EEC-RF0V684 ERA-3YEB153V ELC-3FN2R2N ERA-3YEB512V ERJ-1GEJ564C ERZ-V20R391 ETQ-P3W3R3WFN ELL-ATV681M ELL-VGG4R7N ELK-EA100FA EEF-UD0J101R LC-R121R3P ERA-3YEB303V ERZ-V05V680CB EEF-UE0K101R ELK-E101FA EEC-S0HD224V EVQ-PAC05R EVQ-PAG04M ELK-EA222FA LT4H-DC24V LT4HL8-AC24V LT4HW-AC24V LT4HWT8-AC240V LT4HWT-AC240VS CY-122A-P